TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74AC157P,TC74AC157F,TC74AC157FT

#### Quad 2-Channel Multiplexer

The TC74AC157 is an advanced high speed CMOS QUAD 2-CHANNEL MULTIPLEXER fabricated with silicon gate and double-layer metal wiring C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

This device consist of four 2-input digital multiplexer with common select and strobe inputs.

When the **STROBE** input is held "H" level, selection of data is inhibited and all the outputs become "L" level.

The SELECT decoding determines whether the A or B inputs get routed to their corresponding Y outputs.

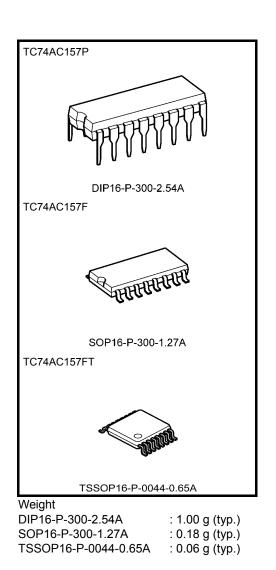
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### Features

- High speed:  $t_{pd}$  = 4.5 ns (typ.) at V<sub>CC</sub> = 5 V
- Low power dissipation:  $I_{CC} = 8 \mu A (max)$  at  $Ta = 25^{\circ}C$
- High noise immunity:  $V_{\text{NIH}} = V_{\text{NIL}} = 28\% V_{\text{CC}}$  (min)
- Symmetrical output impedance: |IOH| = IOL = 24 mA (min)

Capability of driving  $50 \Omega$  transmission lines.

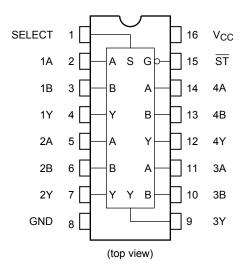
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: V<sub>CC</sub> (opr) = 2 to 5.5 V
- Pin and function compatible with 74F157



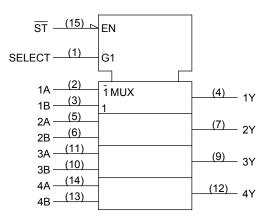
# TC74AC157P/F/FT

# **TOSHIBA**

# **Pin Assignment**



# **IEC Logic Symbol**



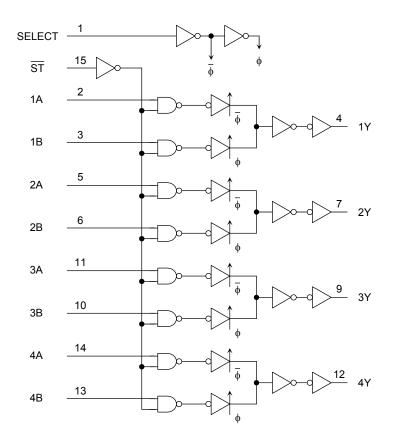
# Truth Table

	Inputs	Output		
ST	SELECT	А	В	Y
Н	Х	Х	Х	L
L	L	L	Х	L
L	L	Н	Х	Н
L	Н	Х	L	L
L	Н	Х	Н	Н

X: Don't care

# System Diagram

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#### Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	I <sub>OK</sub>	±50	mA
DC output current	IOUT	±50	mA
DC V <sub>CC</sub> /ground current	ICC	±100	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP/TSSOP)	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C should be applied up to 300 mW.

# **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dV	0 to 100 (V <sub>CC</sub> = $3.3 \pm 0.3$ V)	ns/V	
	uluv	0 to 20 (V <sub>CC</sub> = 5 $\pm$ 0.5 V)	115/ V	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

# **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition			Ta = 25°C		Ta = −40 to 85°C		Unit		
Characteristics	Symbol			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Onic	
High-level input voltage	V <sub>IH</sub>	_		2.0	1.50	_	_	1.50	_	v	
				3.0	2.10	—	—	2.10	—		
Ŭ				5.5	3.85			3.85			
		_		2.0	—	—	0.50	—	0.50	v	
Low-level input voltage	VIL			3.0	—	—	0.90	—	0.90		
Ŭ				5.5	—		1.65		1.65		
	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>			2.0	1.9	2.0		1.9		- V
			I <sub>OH</sub> = −50 μA		3.0	2.9	3.0	—	2.9	—	
High-level output					4.5	4.4	4.5	-	4.4	-	
voltage			I <sub>OH</sub> = −4 mA		3.0	2.58			2.48		
			I <sub>OH</sub> = −24 mA		4.5	3.94	—	—	3.80	—	
			I <sub>OH</sub> = −75 mA	(Note)	5.5	—	—	—	3.85	—	
	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA		2.0	—	0.0	0.1		0.1	
					3.0	—	0.0	0.1	—	0.1	v
Low-level output					4.5	—	0.0	0.1		0.1	
voltage			I <sub>OL</sub> = 12 mA		3.0	_	_	0.36	_	0.44	v
			I <sub>OL</sub> = 24 mA		4.5	—	—	0.36	—	0.44	
			I <sub>OL</sub> = 75 mA	(Note)	5.5	—				1.65	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	—		±0.1		±1.0	μA	
Quiescent supply current	ICC	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	8.0		80.0	μA	

Note: This spec indicates the capability of driving 50  $\Omega$  transmission lines.

One output should be tested at a time for a 10 ms maximum duration.

# AC Characteristics (C<sub>L</sub> = 50 pF, R<sub>L</sub> = 500 $\Omega$ , input: t<sub>r</sub> = t<sub>f</sub> = 3 ns)

Characteristics	Symbol	Test Condition	Ta = 25°C			Ta = −40 to 85°C		Unit	
	,		$V_{CC}(V)$	Min	Тур.	Max	Min	Max	
Propagation delay time (A, B-Y)	t <sub>pLH</sub> t <sub>pHL</sub>	_	3.3 ± 0.3 5.0 ± 0.5		7.2 5.5	12.2 7.9	1.0 1.0	14.0 9.1	ns
Propagation delay time (SELECT-Y)	t <sub>pLH</sub> t <sub>pHL</sub>	_	3.3 ± 0.3 5.0 ± 0.5		8.5 6.3	14.5 9.1	1.0 1.0	16.7 10.5	ns
Propagation delay time ( ST -Y)	t <sub>pLH</sub> t <sub>pHL</sub>	_	3.3 ± 0.3 5.0 ± 0.5	_	8.6 6.4	14.6 9.2	1.0 1.0	16.8 10.6	ns
Input capacitance	C <sub>IN</sub>	_			5	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub>		(Note)	_	93	—	_	—	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

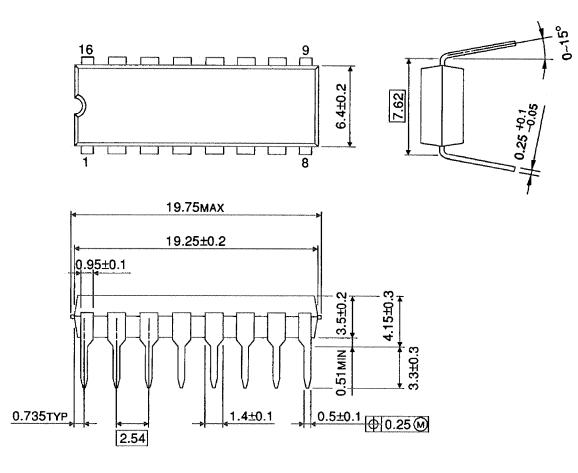
Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4$  (per bit)

#### **Package Dimensions**

DIP16-P-300-2.54A

Unit : mm



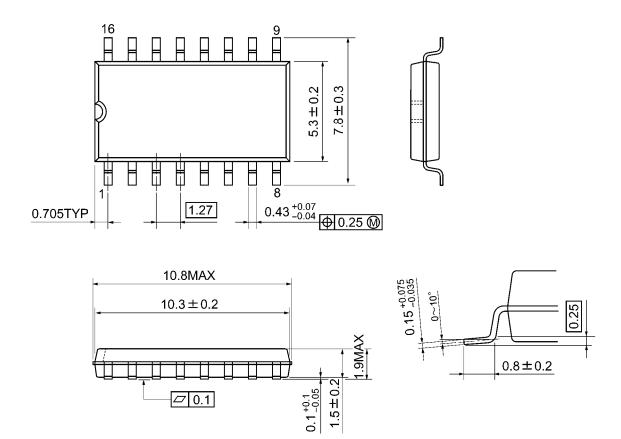
Weight: 1.00 g (typ.)



#### **Package Dimensions**

SOP16-P-300-1.27A

Unit: mm

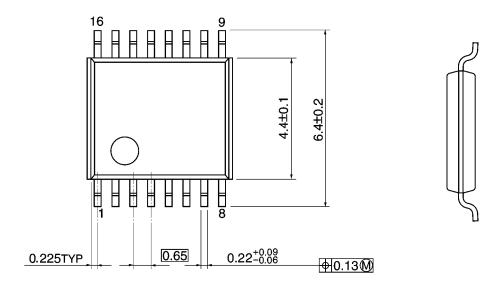


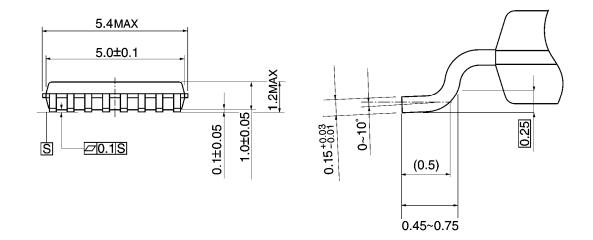
Weight: 0.18 g (typ.)

# **Package Dimensions**

TSSOP16-P-0044-0.65A

Unit: mm





Weight: 0.06 g (typ.)

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